

### SF1056A

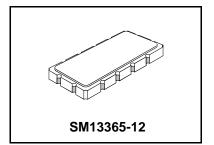
- Designed for DECT and WLAN IF Applications
- **Low Insertion Loss**
- Excellent Size-to-Performance Ratio
- Hermetic 13.3 X 6.5 mm Surface-Mount Case
- Unbalanced Input and Output
- Complies with Directive 2002/95/EC (RoHS)



#### **Absolute Maximum Ratings**

Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Max. DC voltage between any 2 terminals	30	VDC	
Storage Temperature Range	-40 to +85 °C		
Suitable for lead-free soldering - Max Soldering Profile	260°C for 30 s		

# 110.592 MHz **SAW Filter**



#### **Electrical Characteristics**

	Characteristic	Sym	Notes	Min	Тур	Max	Units
Nominal Center	Nominal Center Frequency		1	110.592			MHz
Passband	Insertion Loss at fc	IL			8.5	10.0	dB
	3 dB Passband	BW <sub>3</sub>	1, 2	±576	±750		kHz
	Group Delay Variation over fc ±576 kHz	GDV	1, 2		<150	200	ns <sub>P-P</sub>
Rejection	fc-3.4 to fc-1.728 and fc+1.728 to fc+3.4 MHz			28	40		
	DC to fc-3.4 and fc+3.4 to 200 MHz		1, 2, 3	40	>45		dB
	Ultimate				45		
Operating Temperature Range		T <sub>A</sub>	1	-10		+60	°C

Impedance Matching to 50 $\Omega$ unbalanced	External L-C
Case Style	SM13365-12 13.3 X 6.5 mm Nominal Footprint
Lid Symbolization (YY=year, WW=week) See note 4	RFM SF1056A YYWW

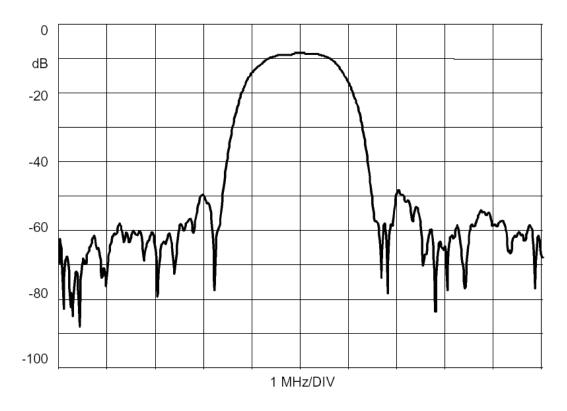
#### **Electrical Connections**

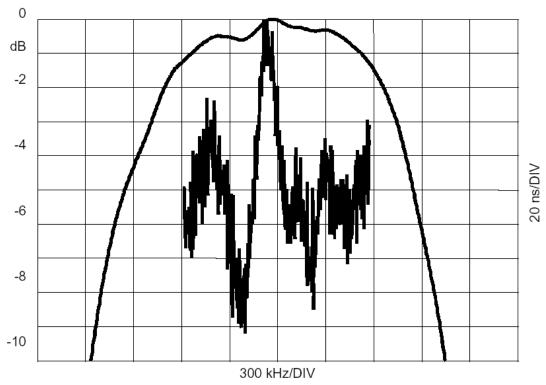
Connection	Terminals
Port 1Hot	2
Port 1 Gnd Return	3
Port 2 Hot	8
Port 2 Gnd Return	9
Case Ground	All Others

#### Notes:

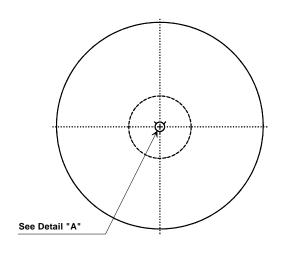
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
- "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- The design, manufacturing process, and specifications of this filter are subject to change.
- Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit
- US and international patents may apply.
- RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc.
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- 10. Electrostatic Sensitive Device. Observe precautions for handling

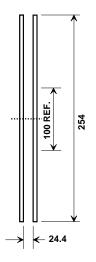




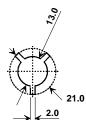


### **Tape and Reel Specifications**

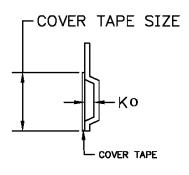




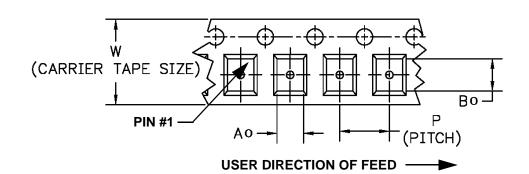
Quantity Per Reel	
100 Min	
1000 Max	



#### **COMPONENT ORIENTATION and DIMENSIONS**

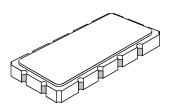


Carrier Tape Dimensions				
Ao	7.0 mm			
Во	13.8 mm			
Ко	2.0 mm			
Pitch	12.0 mm			
W	24.0 mm			



## SM13365-12 Case

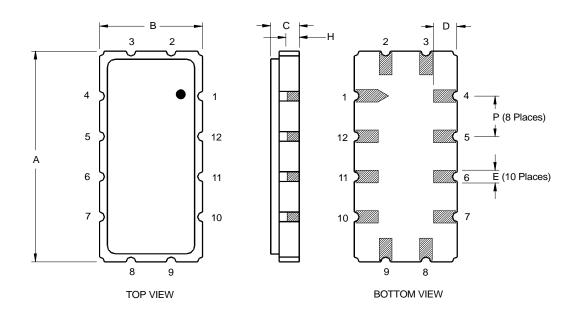
### 12-Terminal Ceramic Surface-Mount Case 13.3 x 6.5 mm Nominal Footprint



	Case Dimensions							
Dimension		mm			Inches			
Difficusion	Min	Nom	Max	Min	Nom	Max		
Α	13.08	13.31	13.60	0.515	0.524	0.535		
В	6.27	6.50	6.80	0.247	0.256	0.268		
С		1.91	2.00		0.075	0.079		
D		1.50			0.059			
E		0.79			0.031			
Н		1.0			0.039			
Р		2.54			0.100			

Materials					
Solder Pad Termination	Au plating 30 - 60 μinches (76.2-152 μm) over 80- 200 μinches (203-508 μm) Ni.				
Lid	Fe-Ni-Co Alloy Electroless Nickel Plate (8-11% Phosphorus) 100-200 µinches Thick				
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic				
Pb Free					

	Electrical Connections					
	Connection	Terminals				
Port 1	Input or Return	2				
	Return or Input	3				
Port 2	Output or Return	8				
	Return or Output	9				
	Ground	All others				
Single	Ended Operation	Return is ground				
Differe	ntial Operation	Return is hot				



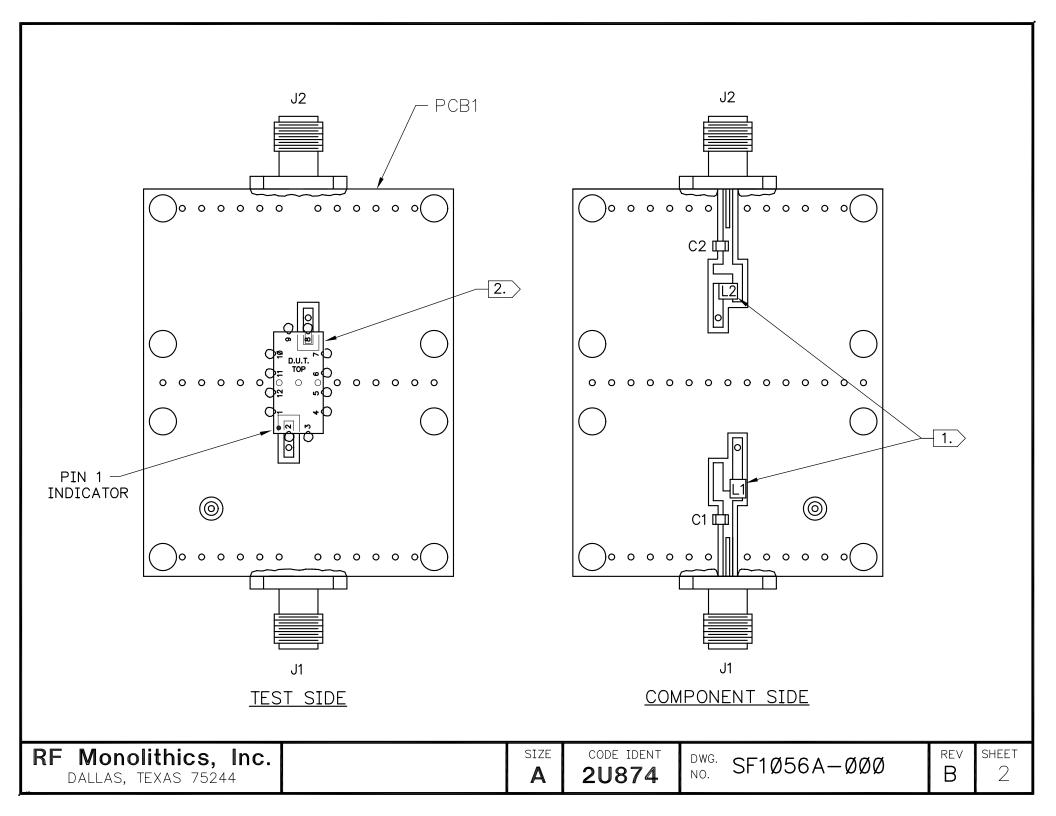
RF Monolithics, Inc. Phone: (972) 233-2903 Fax: (972) 387-8148 RFM Europe Phone: 44 1963 251383 Fax: 44 1963 251510 ©1999 by RF Monolithics, Inc. The stylized RFM logo are registered trademarks of RF Monolithics, Inc.

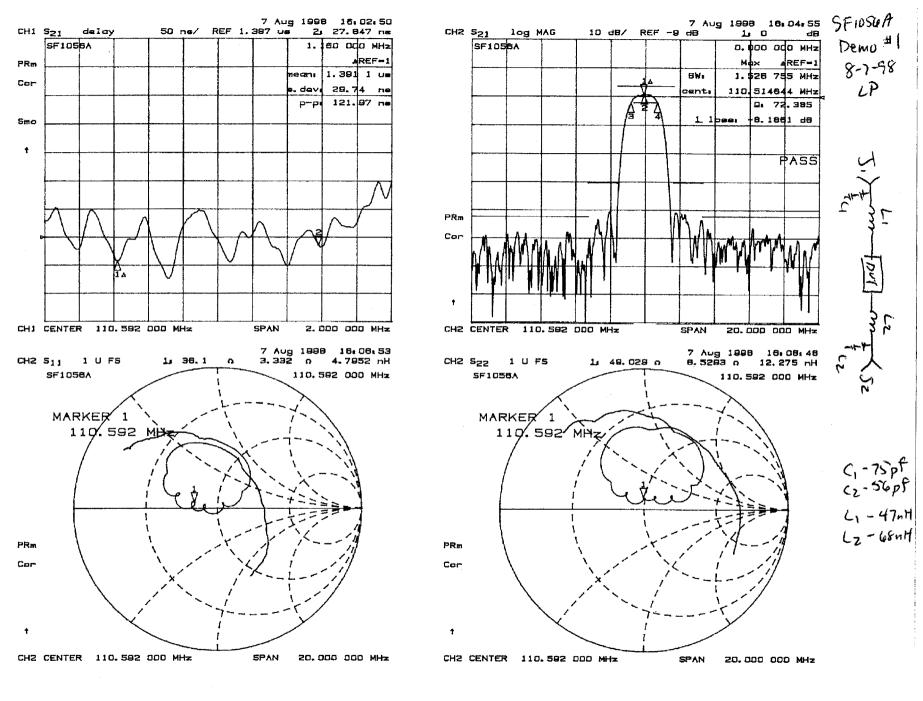
			I
NOTES:	REV	ECN NO.	DESCRIPTION
1. NOTE PROPER ORIENTATION OF INDUCTORS L1 AND L2.	Α	72Ø2	INITIAL RELEASE
THEY ARE TO BE POSITIONED 90° TO EACH OTHER.	В	1Ø145	REVISED PIN NUMBERING
2. SOLDER SURFACE MOUNT PACKAGE TO TEST SIDE OF PCB. SOLDER 12 PLACES AS SHOWN.			
INPUT J1 5Ø Ohm  C1 75pF  D.U.T. (TOP) 3 4 5 6 7	8		L2 68nh ————————————————————————————————————

REV	ECN NO.	DESCRIPTION	DATE
Α	72Ø2	INITIAL RELEASE	
В	1Ø145	REVISED PIN NUMBERING	14sepØ1

OUTPUT J2 5Ø Ohm

DRAWN BY/DATE:	L. ASHM	10RE 15dec98	TITLE:		SF1	Ø56A DEMO PCB		
RF Monoliti	hics, Inc. AS 75244	CHECKED/APPROVED	SIZE <b>A</b>	code ident <b>2U874</b>	DWG. NO.	SF1Ø56A-ØØØ	REV B	SHEET 1/3





SF1056A-000 Rev B

### **BILL OF MATERIALS**

PAI	RT IDENTIFIER	<b>DESCRIPTION 1</b>	<b>DESCRIPTION 2</b>	QTY/ASSY	REFERENCE DESCRIPTION
SF	- 1056A-DEMO	DEMO BOARD, SF1056A			
S	SF1056A-000	ASSY DIGRAM, DEMO BOARD	SF1056A	0	
4	00-0735-001	PCB, DEMO BOARD, 13.3 X 6.5		1.0000	PCB1
5	00-0003-750	CAP ,CHIP, NPO, 75 (J), STD		1.0000	C 1
5	00-0003-560	CAP, CHIP, NPO, 56 (J), STD		1.0000	C 2
5	00-0010-470	IND, CHIP, 1008CS, 47 NH, 10%		1.0000	L 1
5	00-0010-680	IND, CHIP, 1008CS, 68 NH, 10%		1.0000	L 2
5	00-0248-001	CONN,COAX,FLANGE MT.JACK	4 HOLE	2.0000	J 1,2

FRIFIM.

Α

SIZE

**2U874** 

FSCM NO.

DWG NO.

SF1056A-DEMO

SCALE NONE

W/O or ECN

7202

REV **A** 

SHEET 1 05

	REV HISTORY										
REV	ECN	DATE				DESCRIPTION					
А	7202	12/07/98	INITIAL RELEAS	SE							
				ı	1		_				
				FRIFIMI.	SIZE	FSCM NO. <b>2U874</b>	DWG NO.	S	F1056	A-DEM	<b>0</b>
				SCALE NONE	W/O or EO		REV	A	SHEET	2 OF	